

Switching Diode DA2J10100L

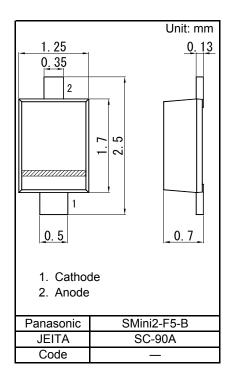
DA2J10100L Silicon epitaxial planar type

For high speed switching circuits

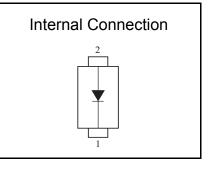
- Features
- Small reverse current IR
- Short reverse recovery time trr
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: A1

Packaging

Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)



Parameter	Symbol	Rating	Unit	
Reverse voltage	VR	80	V	
Maximum peak reverse voltage	VRM	80	V	
Forward current	IF	100	mA	
Peak forward current	IFM	225	mA	
Non-repetitive peak forward surge current *1	IFSM	500	mA	
Junction temperature	Tj	150	°C	
Operating ambient temperature	Topr	-40 to +85	°C	
Storage temperature	Tstg	-55 to +150	°C	
Note) *1: t = 1 s				



■ Absolute Maximum Ratings Ta = 25 °C

Panasonic

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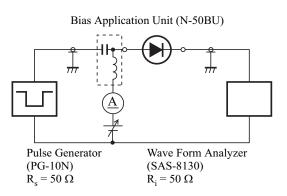
■ Electrical Characteristics Ta = 25 °C ± 3 °C

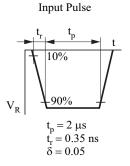
Parameter	Symbol	Conditions	Min	Тур	Max	Unit	
Forward voltage	VF	IF = 100 mA		0.92	1.20	V	
Reverse voltage	VR	IR = 100 μA	80			V	
Reverse current	IR	VR = 80 V			100	nA	
Terminal capacitance	Ct	VR = 0 V , f = 1 MHz			1.2	pF	
Reverse recovery time *1	trr	IF = 10 mA, VR = 6 V Irr = 0.25 x IR			3	ns	

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.

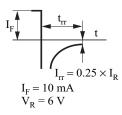
2. Absolute frequency of input and output is 100 MHz.

3. *1: trr test circuit





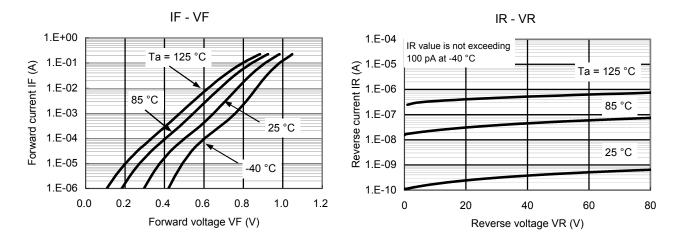


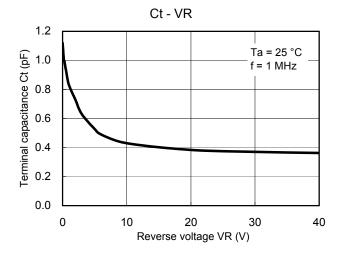




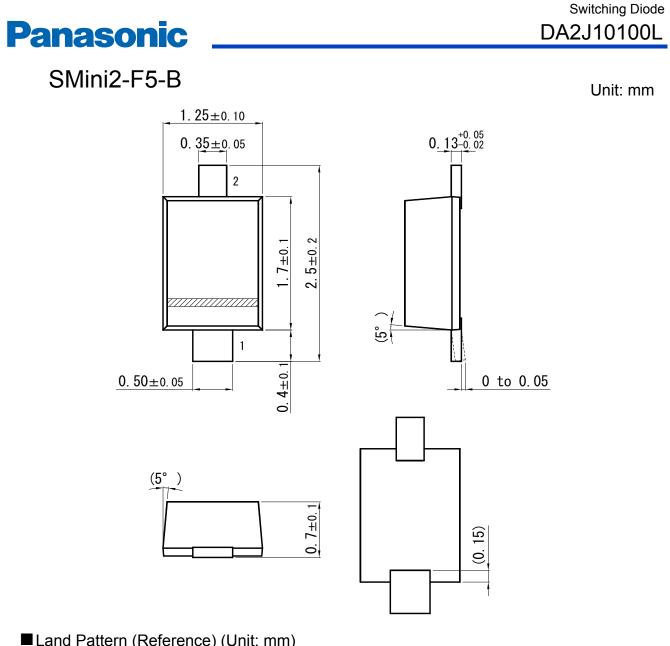
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Technical Data (reference)

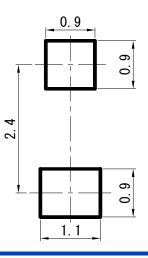




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Land Pattern (Reference) (Unit: mm)



Page 4 of 4

Established : 2009-09-11 Revised : 2013-05-29

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